

2SB1219, 2SB1219A

Silicon PNP epitaxial planar type

For general amplification

Complementary to 2SD1820 and 2SD1820A

■ Features

- Large collector current I_C
- S-Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Collector to base voltage	2SB1219	-30	V
	2SB1219A	-60	
Collector to emitter voltage	2SB1219	-25	V
	2SA1219A	-50	
Emitter to base voltage	V_{EBO}	-5	V
Peak collector current	I_{CP}	-1	A
Collector current	I_C	-0.5	A
Collector power dissipation	P_C	150	mW
Junction temperature	T_j	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

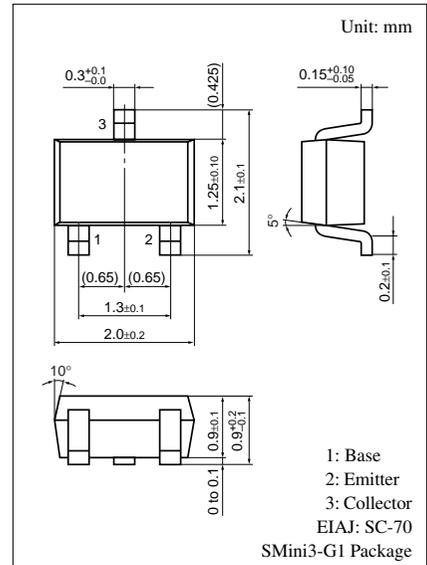
■ Electrical Characteristics $T_a = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector cutoff current	I_{CBO}	$V_{CB} = -20\text{ V}, I_E = 0$			-0.1	μA
Collector to base voltage	2SB1219	$I_C = -10\ \mu\text{A}, I_E = 0$	-30			V
	2SB1219A		-60			
Collector to emitter voltage	2SB1219	$I_C = -2\ \text{mA}, I_B = 0$	-25			V
	2SA1219A		-50			
Emitter to base voltage	V_{EBO}	$I_E = -10\ \mu\text{A}, I_C = 0$	-5			V
Forward current transfer ratio *1	h_{FE1} *2	$V_{CE} = -10\ \text{V}, I_C = -150\ \text{mA}$	85		340	
	h_{FE2}	$V_{CE} = -10\ \text{V}, I_C = -500\ \text{mA}$	40			
Collector to emitter saturation voltage *1	$V_{CE(sat)}$	$I_C = -300\ \text{mA}, I_B = -30\ \text{mA}$		-0.35	-0.6	V
Base to emitter saturation voltage *1	$V_{BE(sat)}$	$I_C = -300\ \text{mA}, I_B = -30\ \text{mA}$		-1.1	-1.5	V
Transition frequency	f_T	$V_{CB} = -10\ \text{V}, I_E = 50\ \text{mA}, f = 200\ \text{MHz}$		200		MHz
Collector output capacitance	C_{ob}	$V_{CB} = -10\ \text{V}, I_E = 0, f = 1\ \text{MHz}$		6	15	pF

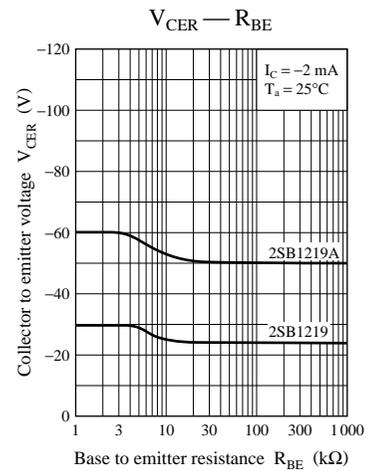
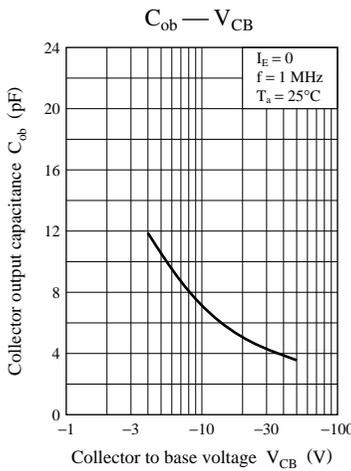
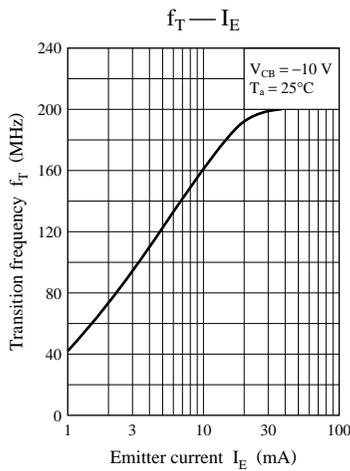
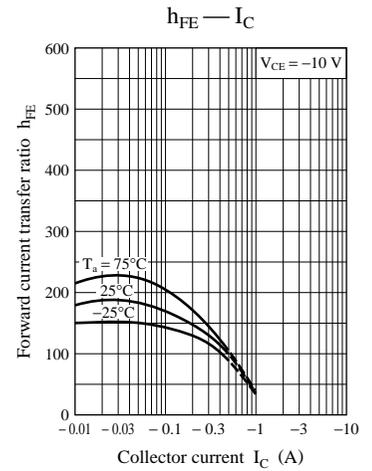
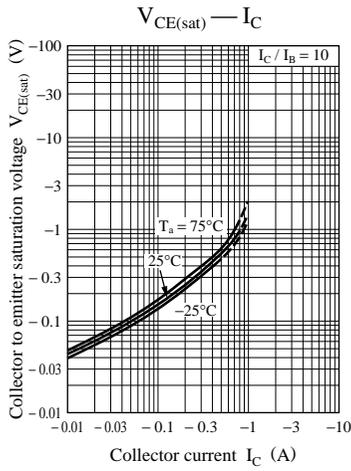
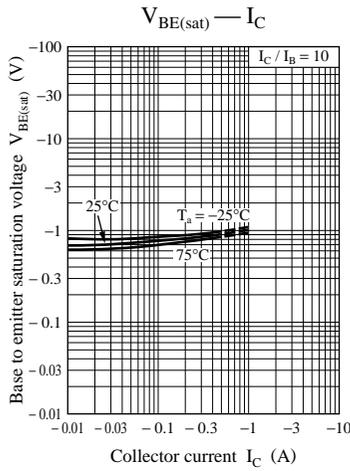
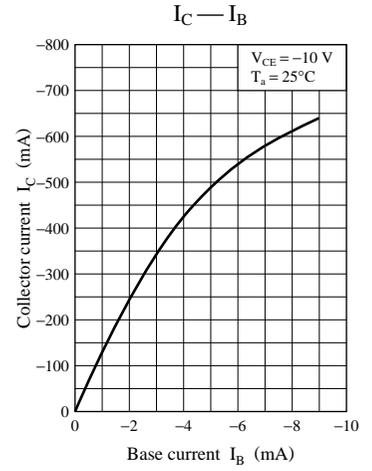
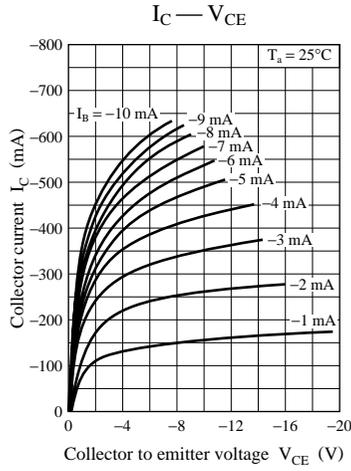
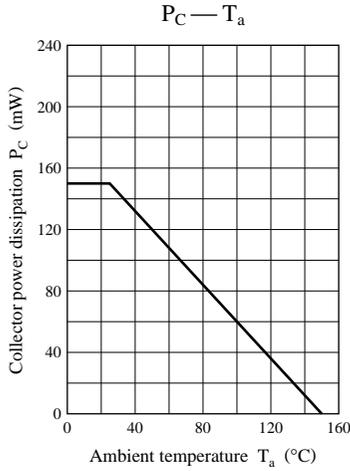
Note) *1: Pulse measurement

*2: h_{FE} Rank classification

Rank	Q	R	S	
h_{FE1}	85 to 170	120 to 240	170 to 340	
Marking symbol	2SB1219	CQ	CR	CS
	2SB1219A	DQ	DR	DS



Marking symbol: C (2SB1219)
D (2SB1219A)



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